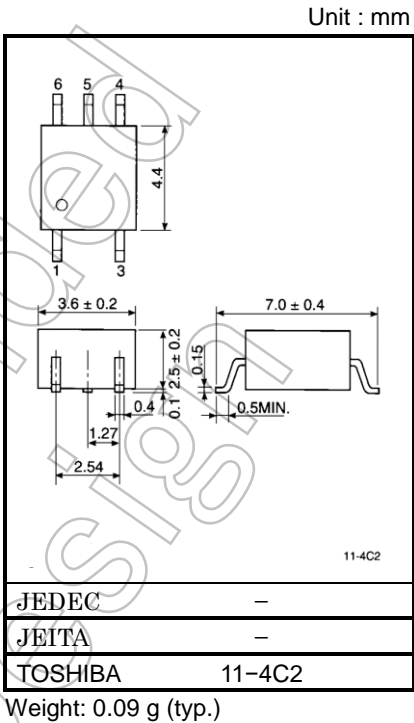


TLP112A

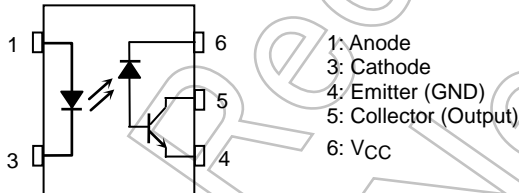
Interfaces of measuring and control instruments  
Digital Logic Isolation  
Line Receiver  
Switching Power Supply Feedback Control  
Industrial Inverter

The TOSHIBA mini flat coupler TLP112A is a small outline coupler, suitable for surface mount assembly.  
TLP112A consists of a high output power infrared emitting diode, optically coupled to a high speed detector of one chip photodiode-transistor.

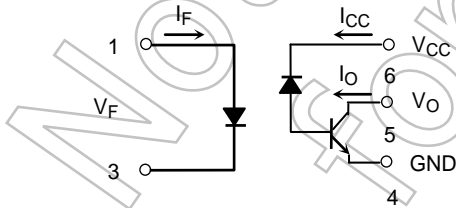
- Isolation voltage: 2500Vrms (min)
- Switching speed:  $t_{pHL}=0.8\mu s$ ,  $t_{pLH}=0.8\mu s(max)(@R_L=1.9k\Omega)$
- TTL compatible by connecting external resistance
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A  
File No.E67349



Pin Configuration(top view)



Schematic



Start of commercial products  
1989-05

## Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
LED	Forward current	I <sub>F</sub>	20	mA
	Forward Current Derating (Ta ≥ 70 °C)	Δ I <sub>F</sub> /°C	-0.36	mA/°C
	Pulse forward current (Note 1)	I <sub>FP</sub>	40	mA
	Peak transient forward current (Note 2)	I <sub>FPT</sub>	1	A
	Reverse voltage	V <sub>R</sub>	5	V
	Diode power dissipation (Note 3)	P <sub>D</sub>	45	mW
Detector	Output current	I <sub>O</sub>	8	mA
	Peak output current	I <sub>OP</sub>	16	mA
	Supply voltage	V <sub>CC</sub>	-0.5 to 15	V
	Output voltage	V <sub>O</sub>	-0.5 to 15	V
	Output power dissipation	P <sub>O</sub>	100	mW
	Output Power Dissipation Derating (Ta ≥ 70°C)	Δ P <sub>O</sub> /°C	-1.8	mW/°C
Operating temperature range		T <sub>opr</sub>	-55 to 100	°C
Storage temperature range		T <sub>stg</sub>	-55 to 125	°C
Lead soldering temperature(10 s)		T <sub>sol</sub>	260	°C
Isolation voltage (AC, 60 s, R.H ≤ 60 %)		BV <sub>S</sub>	2500	V <sub>rms</sub>

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1) 50 % duty cycle, 1ms pulse width. Derate 1.6 mA / °C above 70 °C

(Note 2) Pulse width ≤ 1 μs, 300 pps.

(Note 3) Derate 0.9 mW / °C above 70 °C

(Note 4) This device is regarded as a two terminal device: pins 1 and 3 are shorted together, as are pins 4, 5 and 6.

## Electrical Characteristics(Ta = 25°C)

Characteristics		Symbol	Test Condition	Min.	Typ.	Max.	Unit
LED	Forward voltage	$V_F$	$I_F = 16 \text{ mA}$	1.22	1.42	1.72	V
	Forward voltage temperature coefficient	$\Delta V_F / \Delta T_a$	$I_F = 16 \text{ mA}$	—	-2	—	mV / °C
	Reverse current	$I_R$	$V_R = 3 \text{ V}$	—	—	10	$\mu\text{A}$
	Capacitance between terminals	$C_T$	$V_F = 0 \text{ V}, f = 1 \text{ MHz}$	—	30	—	pF
Detector	High level output current	$I_{OH(1)}$	$I_F = 0 \text{ mA}, V_{CC} = V_O = 5.5 \text{ V}$	—	3	500	nA
		$I_{OH(2)}$	$I_F = 0 \text{ mA}, V_{CC} = V_O = 15 \text{ V}$	—	—	5	$\mu\text{A}$
		$I_{OH}$	$I_F = 0 \text{ mA}, V_{CC} = V_O = 15 \text{ V}$ $T_a = 70^\circ\text{C}$	—	—	50	
	High level supply current	$I_{CCH}$	$I_F = 0 \text{ mA}, V_{CC} = 15 \text{ V}$	—	0.01	1	$\mu\text{A}$
Coupled	Current transfer ratio	$I_O / I_F$	$I_F = 16 \text{ mA}, V_{CC} = 4.5 \text{ V}$ $V_O = 0.4 \text{ V}$	20	—	—	%
	Low level output voltage	$V_{OL}$	$I_F = 16 \text{ mA}, V_{CC} = 4.5 \text{ V}$ $I_O = 2.4 \text{ mA}$	—	—	0.4	V
	Isolation resistance	$R_S$	$R_{H.L.} \leq 60\%$ $V_S = 500 \text{ VDC}$ (Note 1)	$5 \times 10^{10}$	$10^{14}$	—	$\Omega$
	Stray capacitance between input to output	$C_S$	$V_S = 0 \text{ V}, f = 1 \text{ MHz}$ (Note 1)	—	0.8	—	pF

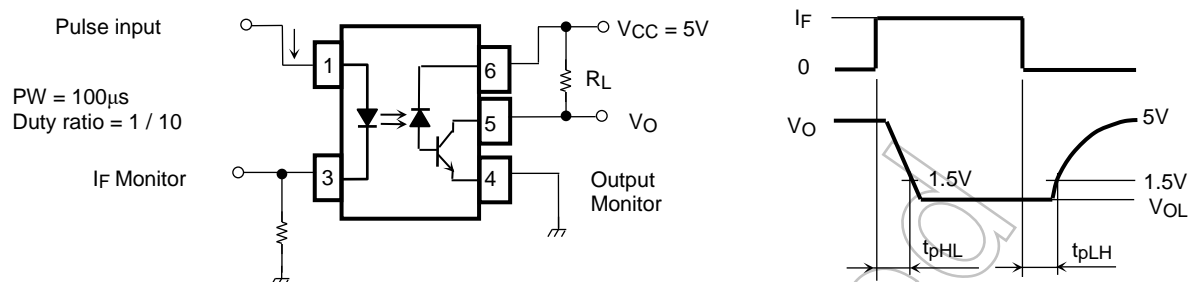
(Note 1) Device considered a two-terminal device: Pins 1 and 3 shorted together and pin 4, 5 and 6 shorted together.

## Switching Characteristics(Ta = 25°C, Vcc=5V)

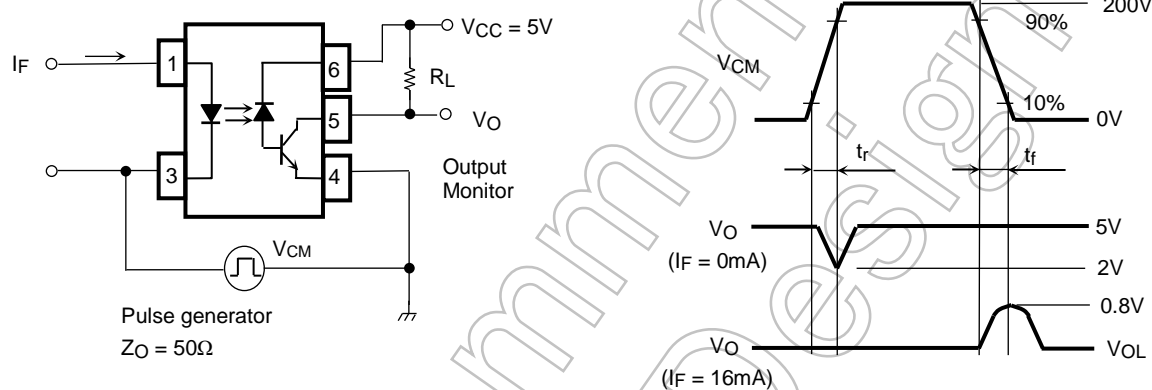
Characteristics	Symbol	Test Circuit	Test Condition	Min.	Typ.	Max.	Unit
Propagation delay time (H→L)	$t_{pHL}$	1	$I_F = 0 \rightarrow 16 \text{ mA}$ $V_{CC} = 5 \text{ V}, R_L = 1.9 \text{ k}\Omega$	—	—	0.8	$\mu\text{s}$
Propagation delay time (L→H)	$t_{pLH}$	1	$I_F = 16 \rightarrow 0 \text{ mA}$ $V_{CC} = 5 \text{ V}, R_L = 1.9 \text{ k}\Omega$	—	—	0.8	$\mu\text{s}$
Common mode transient immunity at high output level	$CM_H$ (Note 2)	2	$I_F = 0 \text{ mA}, V_{CM} = 200 \text{ V}_{p-p}$ $R_L = 4.1 \text{ k}\Omega$	—	1500	—	V / $\mu\text{s}$
Common mode transient immunity at low output level	$CM_L$ (Note 2)	2	$I_F = 16 \text{ mA}, V_{CM} = 200 \text{ V}_{p-p}$ $R_L = 4.1 \text{ k}\Omega$	—	-1500	—	V / $\mu\text{s}$

(Note 2) :  $CM_L$  is the maximum falling common mode voltage waveform (voltage/time) that can keep low level ( $V_O < 0.8 \text{ V}$ ).  
 $CM_H$  is the maximum rising common mode voltage waveform (voltage/time) that can keep high level ( $V_O > 2.0 \text{ V}$ ).

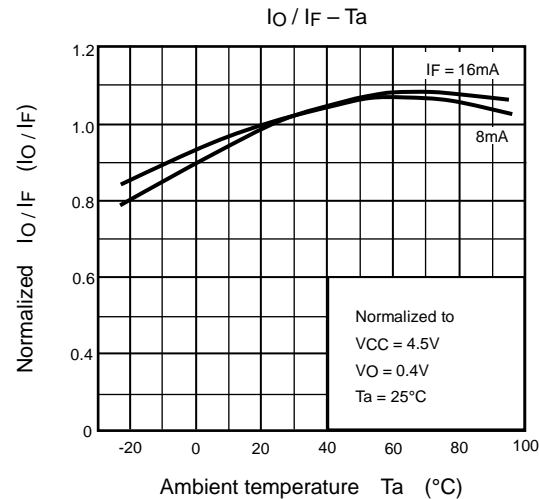
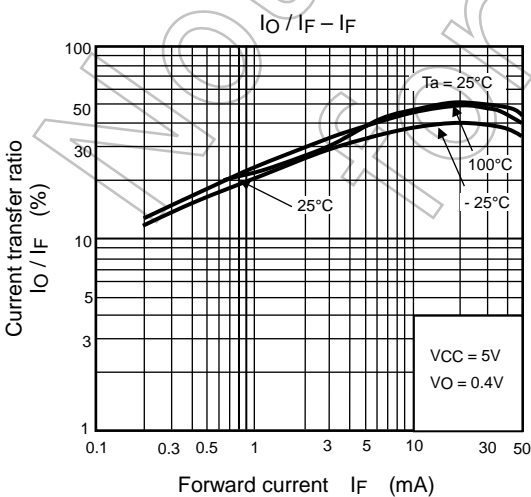
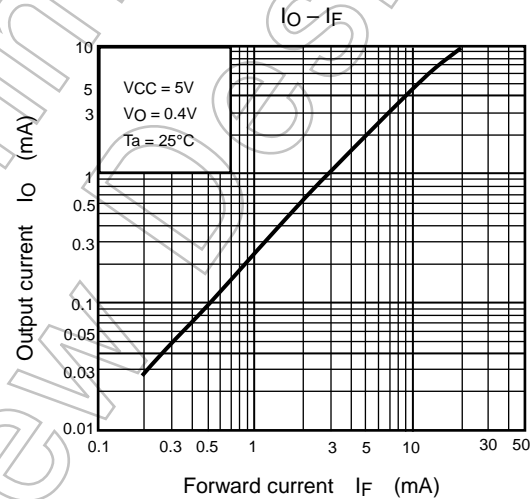
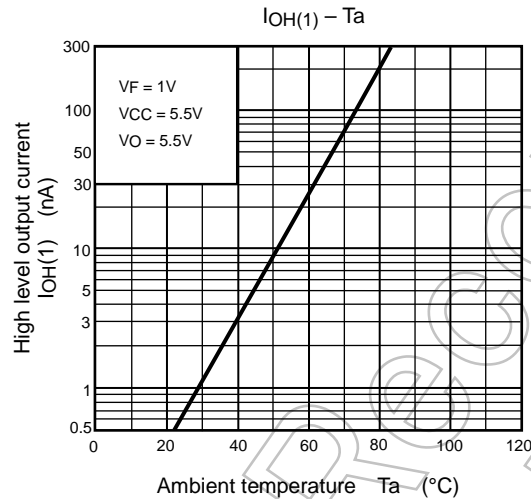
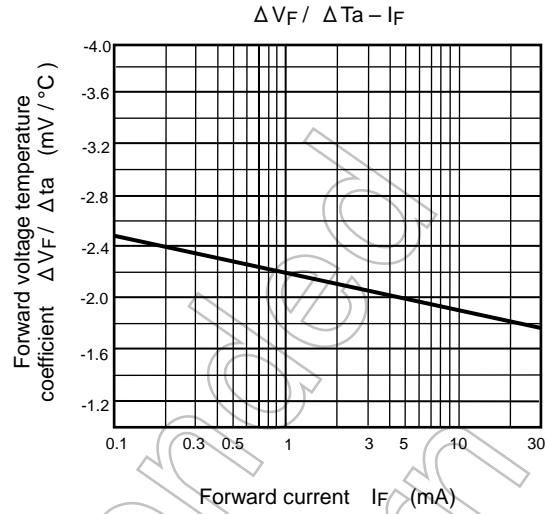
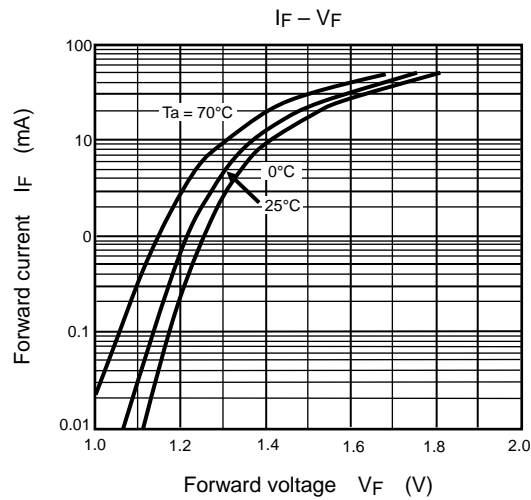
## Test Circuit 1: Switching Time Test Circuit



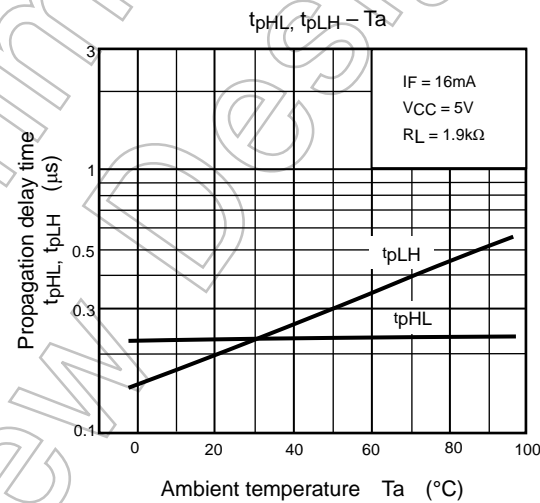
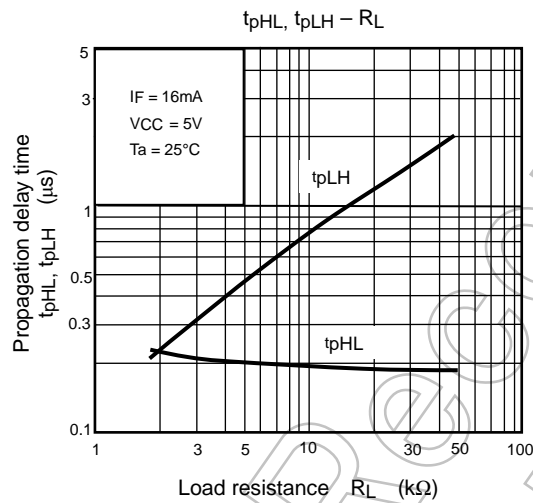
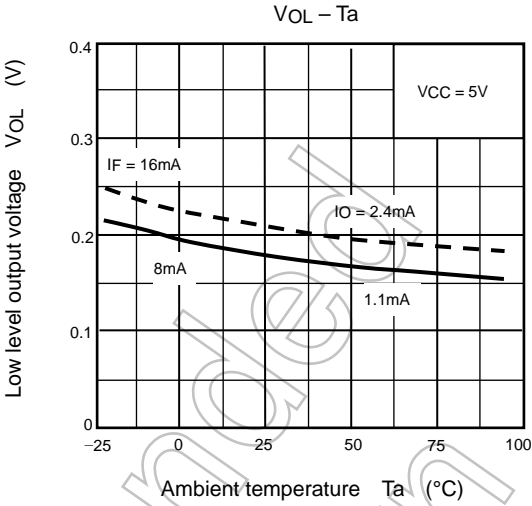
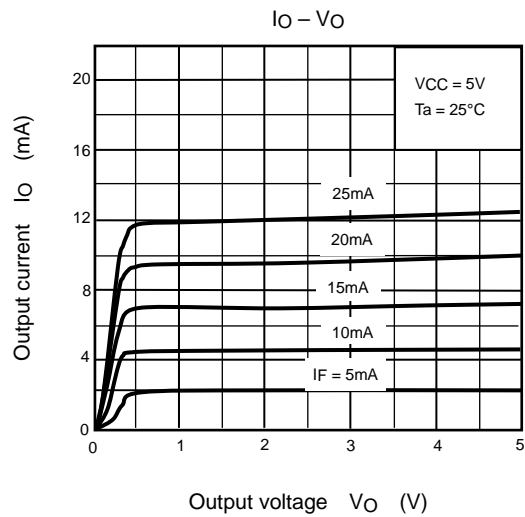
## Test Circuit 2: Common Mode Transient Immunity Test Circuit



$$CM_H = \frac{160(V)}{t_r(\mu s)}, CM_L = \frac{160(V)}{t_f(\mu s)}$$



NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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